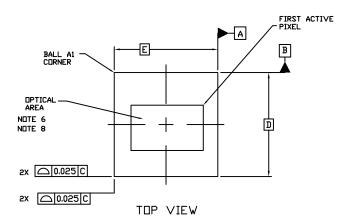
## ODCSP69 5.545x5.565

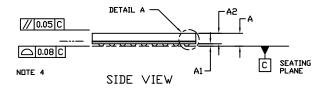
CASE 570BV ISSUE B

**DATE 02 MAY 2018** 



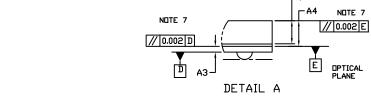
## NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSION  $\phi$  IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER PARALLEL TO DATUM C.
- COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- 5. DATUM C, THE SEATING PLANE, IS DEFINED BY THE SPERICAL CROWNS OF THE SOLDER BALLS.
- 6. MAXIMUM ROTATION OF OPTICAL AREA RELATIVE TO D AND E WILL BE 0.1\*. OPTICAL AREA IS DEFINED BY THE ACTIVE PIXEL ARRAY. REFER TO THE DEVICE DATASHEET FOR TOTAL ARRAY AND FIRST ACTIVE PIXEL DEFINITIONS.
- 7. PARALLELISM APPLIES ONLY TO THE OPTICAL AREA.
- OPTICAL CENTER OFFSET WITH RESPECT TO THE PACKAGE CENTER IS X=62 MICRONS, Y=-171 MICRONS ±25 MICRONS.



DIM	MIN.	MAX.
Α		0.77
A1	0.10	0.16
A2	0.56 REF	
A3	0.090	0.140
A4	0.425	0.465
b	0.22	0.28
D	5.565 BSC	
Ε	5.545 BSC	
e	0.66 BSC	
e1	0.57 BSC	
F	0.38	0.42

MILLIMETERS



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С	0000000	1.00000001
В	10000000	
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	0.05@ C A B 1 2 3 4 5 6 7 8 9	PACKAGE DUTLINE
		RECOMMENDED
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	BOTTOM VIEW	MOUNTING FOOTPRINT

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DESCRIPTION:	ODCSP69 5.545x5.565		PAGE 1 OF 1

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